



D5V0L1B2LP3

#### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

### **Features**

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6mm x 0.3mm x 0.3mm)
- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

### Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0002 grams (Approximate)



Top View

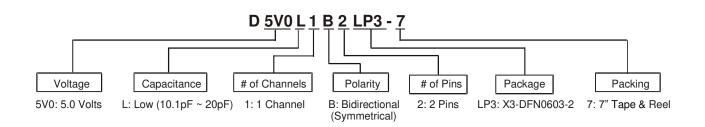


Bottom View



Device Schematic

Ordering Information (Note 4)



Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
D5V0L1B2LP3-7	Standard	N	7	8	10,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**

X3-DFN0603-2

N

N = Product Type Marking Code



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	PPP	84	W	8/20μs, Per Fig. 1
Peak Pulse Current	IPP	6	А	8/20μs, Per Fig. 1
ESD Protection – Contact Discharge	Vesd_contact	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V <sub>ESD_AIR</sub>	±30	kV	Standard IEC 61000-4-2

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

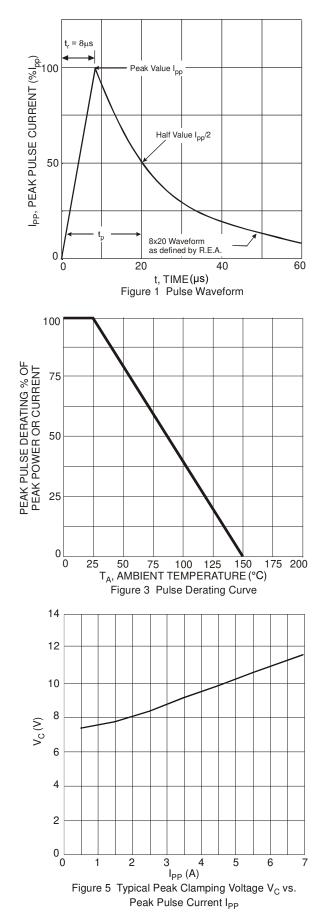
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	VRWM	_	—	5	V	—
Channel Leakage Current (Note 6)	IRM	—	10	100	nA	VRWM = 5V
Clamping Voltage, Positive Transients		—	7.0	9.0	V	IPP = 1A, tp = 8/20µs, Figure 1
		_	8.7	10.7		IPP = 3A, tp = 8/20µs, Figure 1
	VcL	_	10.5	12.0		IPP = 5A, tp = 8/20µs, Figure 1
		_	11.5	14.0		IPP = 6A, tp = 8/20µs, Figure 1
Breakdown Voltage	V <sub>BR</sub>	6	7	8	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DIF</sub>	_	0.2	_	Ω	I <sub>R</sub> = 1A, tp = 8/20µs
ESD Clamping Voltage (Note 7)	N	_	9.6	_	v	IPP = 4A, tp = 10/100ns
	Vc	_	16.0	_		IPP = 16A, tp = 10/100ns
Channel Input Capacitance		—	15	18	pF	$V_R = 0V, f = 1MHz$
	Ст	_	12.5	—		V <sub>R</sub> = 2.5V, f = 1MHz

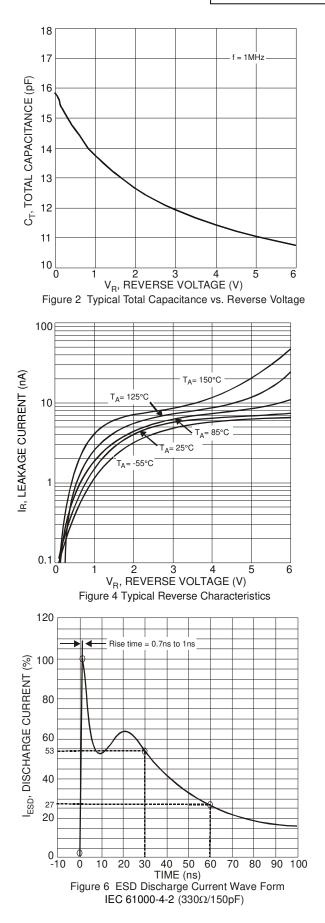
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.

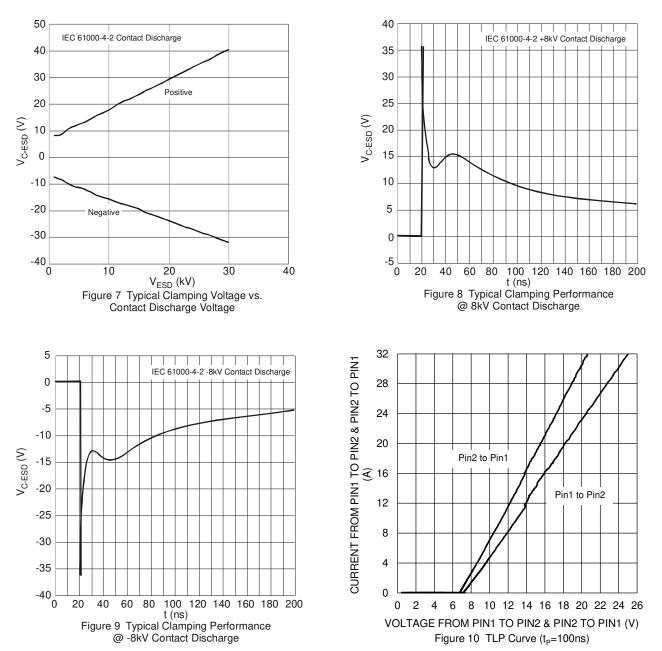
7. Transmission Line Pulse Test (TLP) settings: tp=100ns, tr=10ns, ITLP and VTLP averaging window is from 70ns to 90ns.









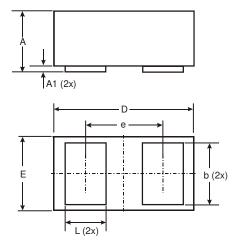




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

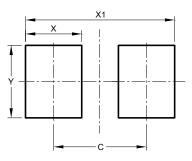
#### X3-DFN0603-2



X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
Е	0.295	0.345	0.32		
е	-	-	0.355		
L	0.14	0.24	0.19		
All Dimensions in mm					

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)	
С	0.380	
Х	0.230	
X1	0.610	
Y	0.300	

#### X3-DFN0603-2



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